505540095 06/24/2019

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5586892

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
BO-DUO YUAN	04/29/2019
HAI-TAO WANG	04/29/2019

RECEIVING PARTY DATA

Name:	HONGFUJIN PRECISION ELECTRONICS (ZHENGZHOU) CO., LTD.	
Street Address:	Comprehensive Bonded Area, East-side of Zhenxing Rd, Zhengzhou Airport District, China	
City:	Zhengzhou	
State/Country:	CHINA	
Name:	Name: HON HAI PRECISION INDUSTRY CO., LTD.	
Street Address:	66, Chung Shan Road, Tu-Cheng Dist.	
City:	New Taipei	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16449769

CORRESPONDENCE DATA

Fax Number: (213)426-1788

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 2134261771

Email: eoa-proce@scienbizip.com,eoa-cbd@scienbizip.com,eoa-procc@scienbizippc.com

Correspondent Name: TUNG-YUN MCNALLY

Address Line 1:550 S. HOPE STREET, SUITE 2825Address Line 4:LOS ANGELES, CALIFORNIA 90071

ATTORNEY DOCKET NUMBER:	US76385
NAME OF SUBMITTER:	TUNG-YUN MCNALLY
SIGNATURE:	/Tung-Yun McNally/
DATE SIGNED:	06/24/2019
Total Attackments O	

Total Attachments: 3

PATENT REEL: 049565 FRAME: 0034 source=US76385190618ASM#page1.tif source=US76385190618ASM#page2.tif source=US76385190618ASM#page3.tif

> PATENT REEL: 049565 FRAME: 0035

ASSIGNMENT

THIS	ASSIGNMENT,	\$332
7 7 7 7 7 7 7 7 7	1200 0 200 1 127 X X X X X X X X	32.7

1.	BO-DUO YUAN	, residing at	Shenzhen,,CN
2.	HAI-TAO WANG	, residing at	Shenzhen,,CN
(hereinaft	er collectively referred to	as the "Assignor"), Wi	TNESSETH:
improve	VHEREAS, said Assignments in a: UTTON RESTORING	gnor has invented MECHANISM ANI	certain new and useful DELECTRONIC DEVICE
HAVING			PERCENTING DEVICE
set forth i	in an application for Letter	s Patent of the United S	tates,
	ng executed concurrently l	nereinwith; or rith U.S. Serial No	

WHEREAS,

HONGFUJIN PRECISION ELECTRONICS (ZHENGZHOU) CO., LTD. a corporation duly and lawfully organized, and having a principal place of business at: Comprehensive Bonded Area, East-side of Zhenxing Rd, Zhengzhou Airport District, China

HON HAI PRECISION INDUSTRY CO., LTD. a corporation duly and lawfully organized, and having a principal place of business at: 66, Chung Shan Road, Tu-Cheng Dist., New Taipei City, Taiwan, R.O.C. and

(hereinafter collectively referred to as the "Assignee"),

is desirous of acquiring the entire right, title and interest in and to said inventions and applications for Letters Patent of the United States, and in and to any Letters Patent or Patents, United States or foreign, to be obtained therefore and thereon:

NOW, THEREFORE, in consideration of one Dollar (\$1.00 USD) and other good and sufficient considerations, the receipt of which is hereby acknowledged, said Assignor has sold, assigned, transferred and set over, and by these presents does sell, assign, transfer and set over, unto said Assignee, its successors, legal representatives and assigns, Assignor's interest in the entire right, title and interest in and to the abovementioned inventions, application for Letters Patent, and any and all Letters Patent or Patents in the United States of America and all foreign countries which may be granted therefore and thereon, and in and to any and all divisions, continuations,

Page Lof 3

Attorney Docket No.: US76385

and continuations-in-part of said application, or reissues or extensions of said Letters Patent or Patents, and all rights under the International Convention for the Protection of Industrial Property, the same to be held and enjoyed by said Assignee, for its own use and behalf and the use and behalf of its successors, legal representatives and assigns, to the full end of the term or terms for which Letters Patent or Patents may be granted, as fully and entirely as the same would have been held and enjoyed by the Assignor, had this saie and assignment not been made;

AND for the same consideration, said Assignor hereby covenants and agrees to and with said Assignee, its successors, legal representatives and assigns, that, at the time of execution and delivery of these presents, said Assignor is the lawful owner of the entire right, title and interest in and to said invention and the application for Letters Patent above mentioned, and that the same is unencumbered and that said Assignor has good and full right and lawful authority to sell and convey the same in the manner herein set forth;

AND for the same consideration, said Assignor hereby covenants and agrees to and with said Assignee, its successors, legal representatives and assigns, that said Assignor will, whenever counsel of said Assignee, or the counsel of its successors, legal representatives and assigns, shall advise that any proceeding in connection with said inventions, or said application for Letters Patent, or any proceeding in connection with Letters Patent for said inventions in any country, including interference proceedings, is lawful and desirable, or that any division, continuation or continuation-in-part of any application for Letters Patent, or any reissue or extension of any Letters Patent, to be obtained thereon, is lawful and desirable, sign all papers and documents, take all lawful oaths, and do all acts necessary or required to be done for the procurement, maintenance, enforcement and defense of Letters Patent for said inventions, without charge to said Assignee, its successors, legal representatives and assigns, but at the cost and expense of said Assignee, its successors, legal representatives and assigns;

ASSIGNOR(S) does/do hereby authorize ASSIGNEE or its patent agents or attorneys to insert, above, the jurisdictions, application numbers, filing dates and any other indicia identifying the Applications when such information is available for the purpose of recording this assignment.

1.	BO-DUO YUAN	2019.429
	BO-DUO YUAN	Date
2.	HAI-TAO WANG	2019. 4.29
	HAI-TAO WANG	Date